

Sound Processors for Home Theater System

# 7.1ch Sound Processor

# BD3452KS

No.10081EAT01

## Description

BD3452KS is a sound processor where the functions including Input Selector, 8ch Volume and Gain Amp required for applications such as AV receivers, home theater systems and mini-component systems are integrated into a single chip. Adopting the BiCMOS process achieves low distortion, low noise and a wide dynamic range.

#### Features

- 1) Dynamic range: 132dB (VOL=MUTE, IHF-A)
- 2) Independent 8 channels for Master Volume (0 to -99 dB, MUTE 1dB/Step)
- 3) Supporting 2nd room entertainment
- 4) Low current consumption design achieved by adopting the BiCMOS process
- 5) Built-in Output Gain Amp useful for adjusting output signal voltages (0 to 15dB, 1dB/Step)
- 6) BD3841FS (9-input selector), BD3843FS (6-input selector) and BUS are common to be controlled simultaneously.
- 7) Built-in 2ch output port
- 8) 2-wire serial control (For both 3.3V and 5V)

#### Applications

AV receivers, home theater systems and mini-component systems

#### ●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Power Supply Voltage	VCC VEE	7.5 <sup>*1</sup> -7.5	V
Input Signal Voltage	VIN	VCC+0.3 to VEE-0.3	V
Power Dissipation	Pd	1300 <sup>*2</sup>	mW
Operating Temperature Range	Topr	-20 to +75	°C
Storage Temperature Range	Tastg	-55 to +125	°C

\*1 Even in the specified range of Power Supply Voltage, applying voltage only to the VCC side may cause an excessive current to give a permanent damage to the IC.

When starting up power supplies, VEE and VCC should be powered on simultaneously or VEE first; then followed by VCC.
Over Ta=25°C, reduce at the rate of 13mW/°C. When installed on the standard board (size: 70×70×1.6mm).

#### Operating conditions

It must function normally at Ta=25°C.

Parameter	Symbol		Ratings		Unit	
Falameter	Symbol	Min.	Тур.	Max.	Unit	
Operating Supply Veltage	VCC	6.5	7	7.3	V	
Operating Supply Voltage	VEE	-7.3	-7	-6.5	.5 V	

# •Electrical characteristics

Ta=25°C, VCC=7V, VEE=-7V, f=1kHz, Vin=1Vrms, RL=10k $\Omega$ , Rg=600 $\Omega$ , Input Gain=0dB, Master volume=0dB. Output gain=0dB, unless otherwise noted.

	ne=0dB, Output gain=0								
Paramete	er	Symbol	Min.		Max.	Unit	Conditions		
o: ::.o .	VCC	10	-	20	40				
Circuit Current	VEE	IQ	-40	-20	-	mA	No signal		
Output Voltage G	ain	Gv	-2	0	2	dB	Measure : Pin87,88		
Total Harmonic Distortion Ratio		THD	-	0.0006	0.03	%	Measure : Pin87,88 BW=400 to 30kHz		
Maximum Output	Voltage	Vomax	3.6	4.2	-	Vrms	Measure : Pin87,88 THD=1%		
Output Noise Volt	tage	Vno	-	1.4	12	μVrms	Measure : Pin87,88, Rg=0 $\Omega$ , BW=IHF-A		
Residual Noise V	oltage	Vnor	-	1	8	μVrms	Measure : Pin87,88, Rg=0Ω, BW=IHF-A, Volume=MUTE		
Cross-talk between Channel	ls	СТС	-	-95	-80	dB	Measure : Pin88(OUTFL),87 (OUTFR) Rg=0Ω, BW=IHF-A Reference : Pin87(OUTFR), 88(OUTFL)=1Vrms		
Cross-talk between Selector	S	CTS	-	-95	-80	dB	Measure : Pin87,88 Rg=0Ω, BW=IHF-A		
Input Impedance		Rin	32	47	62	kΩ			
V Output Voltage	Gain	GVV	-2	0	2	dB	Measure : Pin 81,82,83,84,85,86,87,88		
V Total Harmonic Distortion Ratio			-	0.0006	0.03	%	Measure : Pin 81,82,83,84,85,86,87,88 BW=400 to 30kHz		
V Residual Noise	Residual Noise Voltage			1	8	μVrms	Measure : Pin 81,82,83,84,85,86,87,88 BW=IHF-A, Rg=0Ω,Volume=MUTE		
Volume Setting E	rror	VOLE1	-0.5	0	0.5	dB	Measure : Pin 81,82,83,84,85,86,87,88 Volume=0dB, Vin=3Vrms		
Maximum Attenua	ation	VOLmin	-	-115	-105	dB	Measure : Pin 81,82,83,84,85,86,87,88 Vin=3Vrms, BW=IHF-A		
Input Gain Contro	ol Range	GIG	10	12	14	dB	Measure : Pin 81,82,83,84,85,86,87,88 Input Gain=12dB, Vin=0.3Vrms		
Output Gain Cont	rol Range	GOG	13	15	17	dB	Measure : Pin 81,82,83,84,85,86,87,88 Output Gain=15dB, Vin=0.3Vrms		
Output Gain Setti	ng Error	GOE	-0.5	0	0.5	dB	Measure : Pin 81,82,83,84,85,86,87,88 Output Gain=0dB, Vin=0.3Vrms		
R Output Impeda	t Impedance RoutR - 20 100 Ω Measure : Pin 44,45,4		Measure : Pin 44,45,46,47						
R Voltage Gain	Voltage Gain		-2	0	2	dB	Measure : Pin 44,45,46,47 (*)RL=10kΩ		
R Total Harmonic Distortion Ratio		THDR	-	0.005	0.09	%	Measure : Pin 44,45,46,47 BW=400 to 30kHz, (*)RL=10kΩ		
Port H Output		PH	4.0	4.9	5.4	V	Measure : Pin 62,63 RL=10kΩ		
Port Output Curre		PI			1.0	mA	Measure : Pin 62,63		
	Parameter Circuit Current Output Voltage G Total Harmonic Distortion Ratio Maximum Output Output Noise Volt Residual Noise V Cross-talk between Channel Cross-talk between Selector Input Impedance V Output Voltage V Total Harmonic Distortion Ratio V Residual Noise V Residual Noise V Residual Noise V Residual Noise V Residual Noise Coutput Setting E Maximum Attenua Input Gain Contro Output Gain Contro Output Gain Setti R Output Impeda R Voltage Gain R Total Harmonic Distortion Ratio Port H Output	Parameter     Parameter     Circuit Current   VCC     Output Voltage   VEE     Output Voltage   Imaximum Output     Total Harmonic Distortion Ratio   Valage     Maximum Output Voltage   Imaximum Output     Output Noise Voltage   Imput Inopedance     Cross-talk between Channels   Imput Impedance     Scross-talk Delectors   Imput Impedance     V Output Voltage Gain   Imput Setting Error     V Total Harmonic Distortion Ratio   Valage     V Total Harmonic Range   Imput Gain Control Range     Volume Setting Error   Imput Gain Control Range     Qutput Gain Setting Error   Range     R Voltage Gain   Error     R Voltage Gain   Error     R Voltage Gain   Fror     R Voltage Gain   Fror     Port H Output   Fror	Parameter of VCC VEEIQCircuit Current VotageIQOutput Voltage EGvTotal Harmonic Distortion RatioTHDMaximum Output VoltageVomaxOutput Noise VoltageVonoResidual Noise VoltageVnorCross-talk between Channer SelectorsGCTCCross-talk between SelectorsGCTSInput ImpedanceGOVV Output Voltage GainGVVV Total Harmonic Distortion RatioYnorVV Total Harmonic Distortion RatioYnorVVolume Setting ErrorQOLE1Maximum AttenutonVOLE1Input Gain Control RangeGOGOutput Gain Setting ErrorGOGQutput Gain Setting ErrorGOGNotal Harmonic Distortion RatioGOGNotutage GainGORoutput ImpedanceGONorturi RangeGONation AtternationGONorturi Gain Control RangeGONotput Gain Setting ErrorGORoutput ImpedanceGORoutput ImpedanceGORoutput Gain Setting ErrorGORoutput Gain Setting ErrorGORoutput ImpedanceGORoutput ImpedanceGORoutput ImpedanceGORoutput Gain Setting ErrorGORoutput ImpedanceGURoutput Gain Setting ErrorGORoutput ImpedanceGURoutput ImpedanceGURoutput ImpedanceGURoutput ImpedanceGURoutput Im	$\begin{array}{c c c } \operatorname{Parametric} & \operatorname{Symbol} & [10] \\ \hline \begin{tabular}{ c } & \end{tabular} \\ \hline \begin{tabular}{ c } & t$	ParameterSymbolLimitsVCC $(VEEQ(Q)Q20Output Voltage \existsVCCVEEQQ20Output Voltage \existsGv220Total HarmonicDistortion RatioTHD1-00.0006Maximum Output VoltageVomax3.64.2Output Noise \lorVomax3.64.2Output Noise \lorVomax3.64.2Output Noise \lorVomax3.64.2Cross-talkbetween ChannelsCroc-95Cross-talkbetween ChannelsCrTS-95Input ImpedanceRin3247V Output Voltage \exists ainGVV2.20V Output Voltage \exists ainGVV2.20V output Voltage \exists ainGVV2.20V output Voltage \exists ainGVV2.20V output Voltage \BoxVoltagi0.00611Voltagian AnoisVoltagi01.20Volume Setting \BoxVoltagi0.12011Input Gain Control RangeGIG1315Output Gain Setting \Xi rowGVR2.20Routput ImpedanceRoutputCOC0.005Routput ImpedanceRoutputCOC0.005Routput Gain Control RangeGVR2.20Routput Gain Setting \Xi row102.20$	Parameter     Symbol     Image: space sp	Parametric     Symbol     Image: Ima		

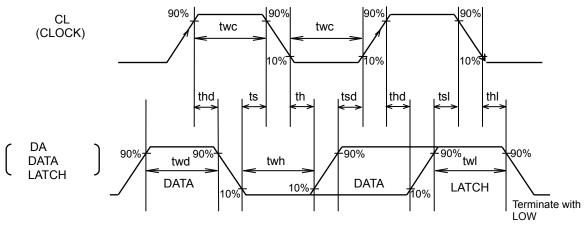
(\*) If two RECOUTs are ON, total load resistances of these two (RL) should be 10 k $\Omega$ .

This product is not of "anti radiation design".

# Timing chart

- 1) Signal Timing Conditions
  - Data is read on the rising edge of the clock.
  - Latch is read on the falling edge of the clock.
  - Latch signal must terminate with the LOW state.

\*To avoid malfunctions, clock and data signals must terminate with the LOW state.



# Fig.1

Parameter	Symbol		Limits		Unit
	Symbol	Min.	Тур.	Max.	Onit
Minimum Clock Width	twc	1.0	-	-	μs
Minimum Data Width	twd	1.0	-	-	μs
Minimum Latch Width	twl	1.0	-	-	μs
LOW Hold Width	twh	1.0	-	-	μs
Data Set-up Time (DATA→CLK)	tsd	0.5	-	-	μs
Data Hold Time (CLK→DATA)	thd	0.5	-	-	μs
Latch Set-up Time (CLK→LATCH)	tsl	0.5	-	-	μs
Latch Hold Time (DATA→LATCH)	thl	0.5	-	-	μs
Latch Low Set-up Time	ts	0.5	-	-	μs
Latch Low Hold Time	th	0.5	-	-	μs

#### 2) Voltage Conditions for Control Signals

Parameter		Limits		Unit	Conditions
Falameter	Min. Typ. Max.		Unit	Conditions	
"H" Input Voltage	2.2	_	5.5	V	Vcc = 6.5~7.3V
"L" Input Voltage	0	_	1.0	V	VEE=-6.5~-7.3V

#### 3) Basic Configuration of Control Data Formats

-	Inpu	t direct	ion														
	MSB																LSB
Data	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Dala							Da	ata							Sele	ct Add	ress

• Con		ita Forr directi													Sele	ct Addı	ess
Data	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
(1)	l.	nput se	lector	1	Ir	nput se	lector 2	2	Input	ATT	Input	gain	*	*	0	0	0
Data	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
(2)		LR Inp Selecto			BLR Inp Selecto		Multi Sele		REC A	REC B	Port A	Port B	*	0	0	0	1
Data	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
(3)	C	Dutput g	gain 7c	:h	Οι	itput ga	ain SW	ch	*	*	*	*	*	1	0	0	1
Data	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
(4)	Г	Master	volum	е		FLch			Master	volum	е		FRch		0	1	0
Data	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
(5)	ſ	Master	volum	e		Cch			Master	volum	e		SWch		0	1	1
Data	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
(6)	ſ	Master	volum	e		SLch			Master	volum	e		SRch		1	1	0
Data	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
(7)	ſ	Master	volum	e		SBLch			Master	volum	e	:	SBRch	ı	1	1	1

By changing the setting of Select Address, seven different control formats are selectable.

For Select Address, the values except those shown above must not be specified.

Each time of power-on, all of the address data must be initialized.

\* indicates 0 or 1.

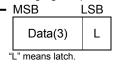
#### (Example)

Input direction

MSB	LS	В	MSB	LSB	MSB	LSB	MSB L	.SB	MSB L	SB	MSB I	SB	MSB L	SB
Data(	(1)	L	Data(2)	) L	Data(3	) L	Data(4)	L	Data(5)	L	Data(6)	L	Data(7)	L
"L" mear	ns latch	n.												

After power-on, for the second and subsequent times, only the desired data can be selected for setting.

(Example) When changing Output Gain SWch, Input direction



# Application circuit

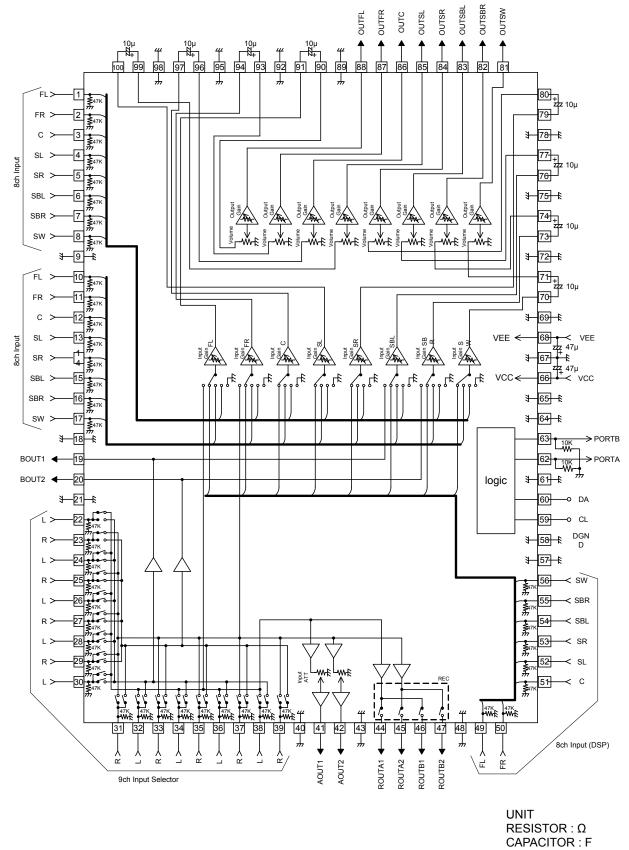


Fig.2

# Reference data

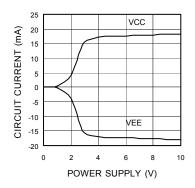
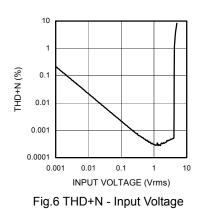


Fig.3 Circuit Current - Power Supply



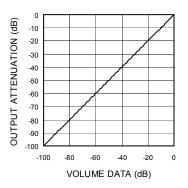


Fig.9 Volume Attenuation -Volume Settin

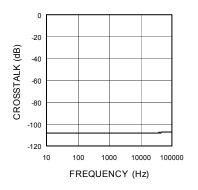


Fig.12 Cross-talk between Selectors -Frequency

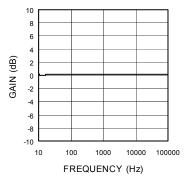


Fig.4 Voltage Gain - Frequency

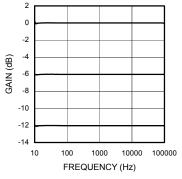


Fig.7 Input Attenuation - Frequency

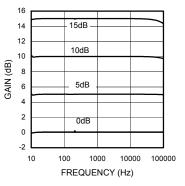


Fig.10 Output Gain - Frequency

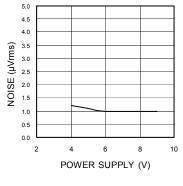


Fig.13 Output Noise Voltage -Power Supply Voltage

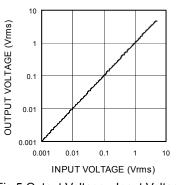


Fig.5 Output Voltage - Input Voltage

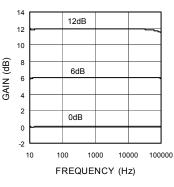


Fig.8 Input Gain - Frequency

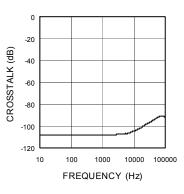
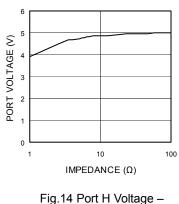


Fig.11 Cross-talk between Channels -Frequency



Ig.14 Port H Voltage Load Resistance

#### Notes for use

- (1) Numbers and data in entries are representative design values and are not guaranteed values of the items.
- (2) Although we are confident in recommending the sample application circuits, carefully check their characteristics further when using them. When modifying externally attached component constants before use, determine them so that they have sufficient margins by taking into account variations in externally attached components and the Rohm LSI, not only for static characteristics but also including transient characteristics.
- (3) Absolute maximum ratings

If applied voltage, operating temperature range, or other absolute maximum ratings are exceeded, the LSI may be damaged. Do not apply voltages or temperatures that exceed the absolute maximum ratings. If you think of a case in which absolute maximum ratings are exceeded, enforce fuses or other physical safety measures and investigate how not to apply the conditions under which absolute maximum ratings are exceeded to the LSI.

(4) VEE potential

Make the VEE pin voltage such that it is the lowest voltage even when operating below it. Actually confirm that the voltage of each pin does not become a lower voltage than the VEE pin, including transient phenomena.

(5) Thermal design

Perform thermal design in which there are adequate margins by taking into account the allowable power dissipation in actual states of use.

(6) Shorts between pins and misinstallation

When mounting the LSI on a board, pay adequate attention to orientation and placement discrepancies of the LSI. If it is misinstalled and the power is turned on, the LSI may be damaged. It also may be damaged if it is shorted by a foreign substance coming between pins of the LSI or between a pin and a power supply or a pin and a GND.

#### (7) Operation in strong magnetic fields

Adequately evaluate use in a strong magnetic field, since there is a possibility of malfunction.

(8) About Operating Voltage Range and Operating Temperature Range

The circuit functional operations are guaranteed within the Operating Voltage Range and Operating Temperature Range. The standard values of electrical characteristics, however, are guaranteed under the specific conditions. Accordingly, careful consideration of the IC characteristic variations is required to design a set of circuit.

(9) About power ON/OFF

(a) At power ON/OFF, a shock sound will be generated and, therefore, use MUTE on the set.

(b) When turning on power supplies, VEE and VCC should be powered on simultaneously or VEE first; then followed by VCC. If the VCC side is started up first, an excessive current may pass VCC through VEE.

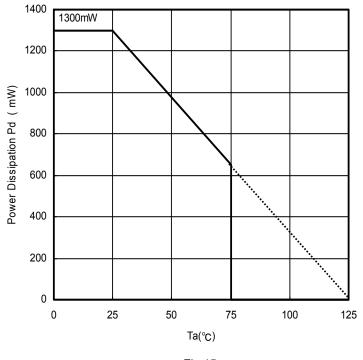
(10) About serial control

For the CL and DA terminals, the patterned and other wirings should be routed not to cause interference with the analog-signal-related lines.

#### (11) About function switching

When switching Input Selector or Input Gain, use MUTE on Master Volume.

# Thermal derating characteristic

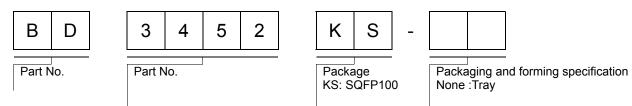




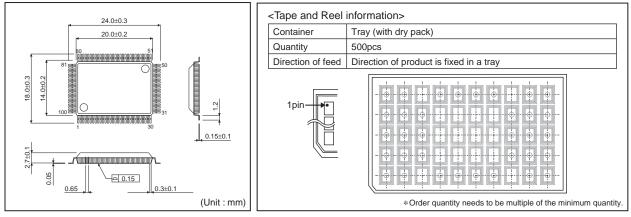
BD3452KS

ROHM standard board packaging time value Board size: 70 x 70 x 1.6mm Raw material : FR4 glass epoxy board (copper area 3% or below)

## Ordering part number



# SQFP100



NI -	
	copying or reproduction of this document, in part or in whole, is permitted without the sent of ROHM Co.,Ltd.
The	content specified herein is subject to change for improvement without notice.
"Prc	content specified herein is for the purpose of introducing ROHM's products (hereinafte ducts"). If you wish to use any such Product, please be sure to refer to the specifications ch can be obtained from ROHM upon request.
illus	mples of application circuits, circuit constants and any other information contained herein trate the standard usage and operations of the Products. The peripheral conditions mus aken into account when designing circuits for mass production.
How	at care was taken in ensuring the accuracy of the information specified in this document rever, should you incur any damage arising from any inaccuracy or misprint of such rmation, ROHM shall bear no responsibility for such damage.
exar impl othe	technical information specified herein is intended only to show the typical functions of and nples of application circuits for the Products. ROHM does not grant you, explicitly o icitly, any license to use or exercise intellectual property or other rights held by ROHM and er parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the of such technical information.
equi	Products specified in this document are intended to be used with general-use electronic pment or devices (such as audio visual equipment, office-automation equipment, commu tion devices, electronic appliances and amusement devices).
The	Products specified in this document are not designed to be radiation tolerant.
	le ROHM always makes efforts to enhance the quality and reliability of its Products, a duct may fail or malfunction for a variety of reasons.
agai failu shal	use be sure to implement in your equipment using the Products safety measures to guard nst the possibility of physical injury, fire or any other damage caused in the event of the re of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM I bear no responsibility whatsoever for your use of any Product outside of the prescribed be or not in accordance with the instruction manual.
syst may instr cont of th	Products are not designed or manufactured to be used with any equipment, device o em which requires an extremely high level of reliability the failure or malfunction of which result in a direct threat to human life or create a risk of human injury (such as a medica rument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel- troller or other safety device). ROHM shall bear no responsibility in any way for use of an the Products for the above special purposes. If a Product is intended to be used for an an special purpose, please contact a ROHM sales representative before purchasing.
be c	ou intend to export or ship overseas any Product or technology specified herein that may controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to ain a license or permit under the Law.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

# ROHM Customer Support System

http://www.rohm.com/contact/